NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6008AS uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

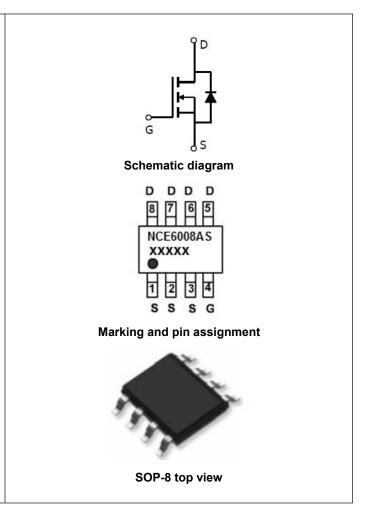
V_{DS} = 60V,I_D =8A

 $R_{DS(ON)} < 16m\Omega @ V_{GS} = 10V$ (Typ:13.5m Ω) $R_{DS(ON)} < 22m\Omega @ V_{GS} = 4.5V$ (Typ:18m Ω)

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses

Application

- Power switching application
- Load switch



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE6008AS	NCE6008AS	SOP-8	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

- 1.00 o							
Parameter	Symbol	Limit	Unit				
Drain-Source Voltage	V _{DS}	60	V				
Gate-Source Voltage	V _G s	±20	V				
Drain Current-Continuous	I _D	8	А				
Drain Current-Continuous(T _C =100 °C)	I _D (100°C)	5.6	Α				
Pulsed Drain Current	I _{DM}	32	Α				
Maximum Power Dissipation	P _D	2.1	W				
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	$^{\circ}$ C				

Thermal Characteristic

	Thermal Resistance,Junction-to-Ambient (Note 2)	$R_{\theta JA}$	60	°C/W			



NCE6008AS

Electrical Characteristics (TC=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
ff Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.0	1.6	2.2	V
Drain Source On State Registeres	В	V _{GS} =10V, I _D =8A	, I _D =8A -		16	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =8A	-	18	22	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =8A	18	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	\/ -20\/\/ -0\/	-	1600	-	PF
Output Capacitance	Coss	V_{DS} =30V, V_{GS} =0V, F=1.0MHz	-	112	-	PF
Reverse Transfer Capacitance	C _{rss}	F-1.UIVIDZ	-	98	-	PF
Switching Characteristics (Note 4)	racteristics (Note 4)					
Turn-on Delay Time	t _{d(on)}		-	7	-	nS
Turn-on Rise Time	tr	V _{DD} =30V, R _L =1Ω	-	5.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =3 Ω	-	29	-	nS
Turn-Off Fall Time	t _f		-	4.5	-	nS
Total Gate Charge	Qg	V 20V/1 0A	-	38.5	-	nC
Gate-Source Charge	Qgs	V _{DS} =30V,I _D =8A,	-	4.7	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	10.3	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =8A	-	-	1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	8	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =8A	-	28	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	40	-	nC

Notes:

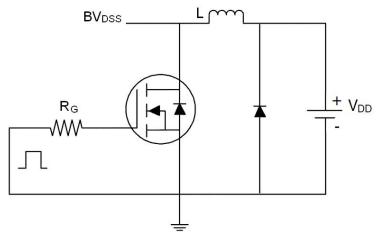
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

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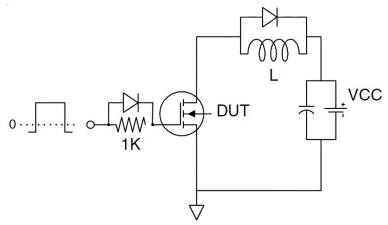


Test Circuit

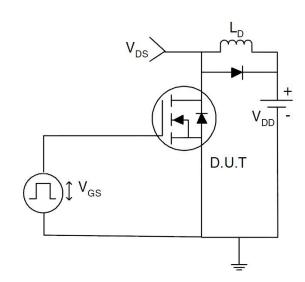
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



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Typical Electrical and Thermal Characteristics (Curves)

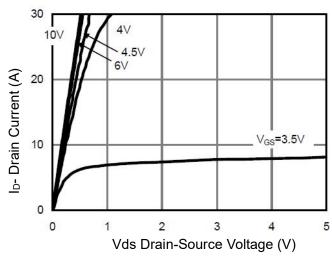


Figure 1 Output Characteristics

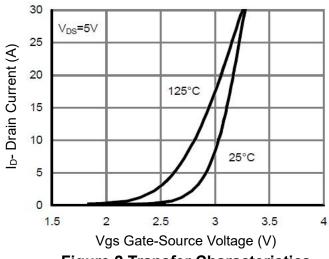


Figure 2 Transfer Characteristics

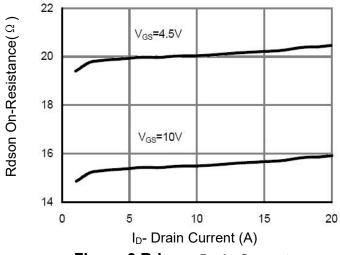


Figure 3 Rdson- Drain Current

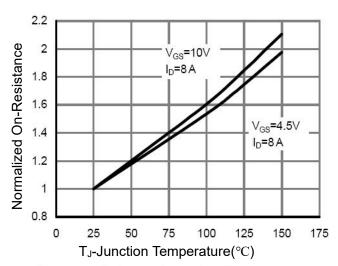


Figure 4 Rdson-JunctionTemperature

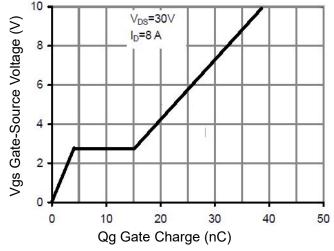


Figure 5 Gate Charge

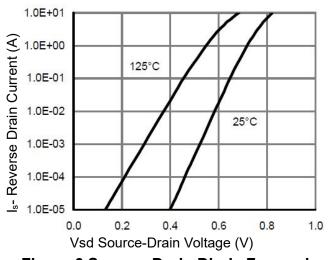


Figure 6 Source- Drain Diode Forward

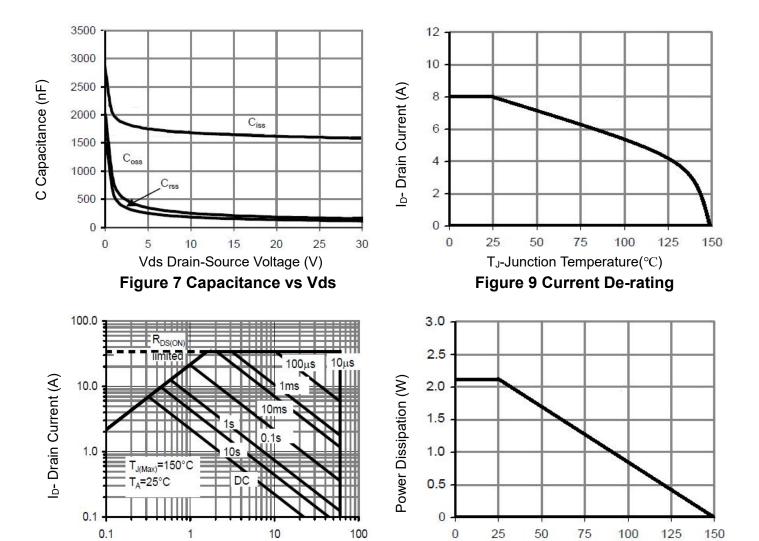
Vds Drain-Source Voltage (V)

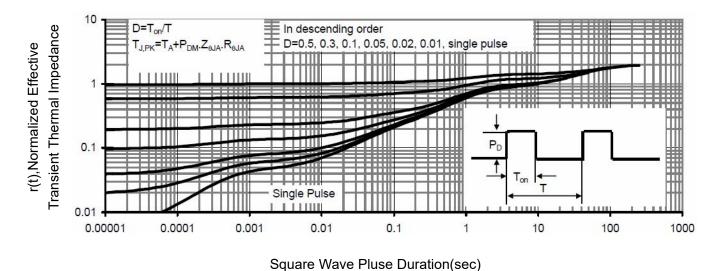
Figure 8 Safe Operation Area

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T_J-Junction Temperature(°C)

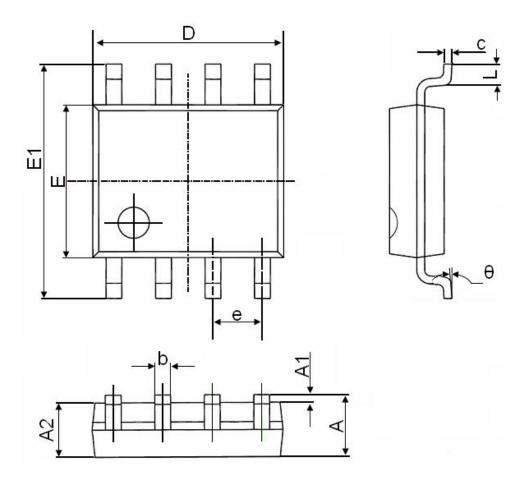
Figure 10 Power De-rating

Figure 11 Normalized Maximum Transient Thermal Impedance

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SOP-8 Package Information



Comple al	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	1.270(BSC)		(BSC)	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	

Attention:



http://www.ncepower.com



NCE6008AS

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